

FireWire Current Limiter and Low-Drop ORing Switch Controller

General Description

The MAX5943 is a fully integrated power-management IC for FireWire[®] applications. This device controls two external power n-channel MOSFETs to regulate current from the input power supply to the load and performs low-voltage-drop, power-supply ORing. The MAX5943 operates over a 7.5V to 37V input range and provides inrush and output current limit in addition to a diode ORing function suitable for FireWire applications. The MAX5943 FireWire/IEEE 1394[™] protective circuit (Figure 12) is UL[®] recognized.

The MAX5943 allows the safe insertion and removal of FireWire peripherals into a live FireWire port by providing inrush current control and an output current-limiting function. The ORing feature provides a very efficient way to protect the FireWire port when connected to another FireWire peripheral that sources a higher voltage. By turning off both external MOSFETS, the MAX5943 provides a true bidirectional load disconnect. A low-current shutdown mode disables the MAX5943, resulting in less than 10μ A supply current. A pin-selectable input allows latched or autoretry fault management after a fault.

The MAX5943A features a current-limit function that actively limits the current drawn by the load with a programmable timeout. The MAX5943B–MAX5943E do not actively limit the load current but provide a circuit-breaker function. See the *Selector Guide* for the default and programmable circuit-breaker timeouts.

The MAX5943 operates over the -40°C to +85°C extended temperature range and is available in a 16-pin QSOP package.

Applications

FireWire Desktop/Notebook Port FireWire Peripheral Device Current Limit FireWire Hub Hot Swap

Typical Operating Circuit and Selector Guide appear at end of data sheet.

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Maxim Integrated Products 1

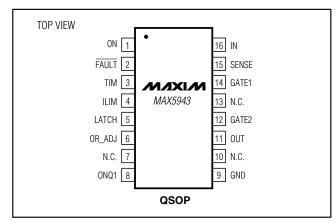
w-Drop ntroller _____Features

- Provides Safe Hot Swap for 7.5V to 37V Power Supplies
- UL-Recognized FireWire/IEEE 1394 Protective Circuit
- ♦ Low-Drop Power ORing with Ultra-Fast Turn-Off
- Programmable Active Current Limit (MAX5943A)
- Programmable Circuit Breaker (MAX5943B–MAX5943E)
- ♦ ±5% Current-Limit Sensing Accuracy
- Programmable Current-Limit/Circuit-Breaker Timeout
- Fast Current-Limit Response to Output Short-Circuit Conditions (MAX5943A)
- Drives External N-Channel Power MOSFETs
- Overcurrent Fault Status Output
- Latched or Autoretry Overcurrent Fault Management
- ♦ 10µA Shutdown Current
- ON/OFF Control Allows Undervoltage Lockout Programming
- ♦ Fast Load Disconnect Control Through ON Input

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX5943AEEE	-40°C to +85°C	16 QSOP
MAX5943BEEE	-40°C to +85°C	16 QSOP
MAX5943CEEE	-40°C to +85°C	16 QSOP
MAX5943DEEE	-40°C to +85°C	16 QSOP
MAX5943EEEE	-40°C to +85°C	16 QSOP
MAX5943EEEE	-40°C to +85°C	16 QSOP

Pin Configuration



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND, unless other	wise noted.)
IN	0.3V to +80V
OUT	0.3V to +80V
SENSE to IN	1V to +0.3V
GATE1 to SENSE	0.3V to +8V
GATE2 to OUT (internally clamped)	0.3V to +8V
FAULT	0.3V to +85V
ON, TIM, ILIM, LATCH, OR_ADJ, ONQ1	0.3V to (IN + 0.3V)

Continuous Power Dissipation (TA = +70°C) 16-Pin QSOP (derate 8.3mW/°C above +70°C).......667mW Operating Temperature Range-40°C to +85°C Maximum Junction Temperature+150°C Storage Temperature Range-60°C to +150°C ESD Rating (Human Body Model)..................2000V Lead Temperature (soldering, 10s).....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{IN} = 7.5V to 37V, GND = 0V, and T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{IN} = 12V, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
SUPPLIES		·					
Supply Voltage Range	VIN			7.5		37	V
Supply Current	I _{IN}	V _{ON} = 3V, no load			1.3	2.3	mA
Shutdown Current	I _{SD}	$V_{ON} = 0.4V$			5	10	μΑ
IN Default Undervoltage Lockout	VUVLO	V_{IN} rising, $ON = IN$		6.2	6.5	6.8	V
IN Default Undervoltage Lockout Hysteresis					0.35		V
ON Undervoltage Lockout Threshold	VON_REF	V _{ON} rising		1.20	1.24	1.275	V
ON Undervoltage Lockout Threshold Hysteresis					70		mV
ON Input Bias Current	ION					1	μA
GATE2 (current-limit/circuit-breake	er control)	·					
GATE2 Pullup Current	I _{G2U}	(Note 2)		36	45	54	μΑ
CATE2 High Voltage	V _{G2}	Vgate2 - Vout	$7.5V \leq V_{IN} \leq 8V$	4.25	5.5	6.5	V
GATE2 High Voltage			$8V \le V_{IN} \le 37V$	4.5	5.5	6.5	
Current Limit/Circuit Dreaker	V _{TH}	VIN - VSENSE	ILIM = GND	47.5	50	52.5	mV
Current-Limit/Circuit-Breaker Threshold Voltage			ILIM = floating	37	39	41	
			ILIM = IN	55	58.5	61	
Fast Dulldours Ourrant Limit			ILIM = GND	70	75	80	mV
Fast Pulldown Current-Limit Threshold Voltage (MAX5943A)	VTHF	VIN - VSENSE (Note 3)	ILIM = floating	54	59	64	
			ILIM = IN	83	88	93	
GATE2 Pulldown Current (MAX5943A)	I _{G2D}	$V_{TH} < (V_{IN} - V_{SENSE}) < V_{THF},$ t < t _{ILIM}		335	435	535	μA
GATE2 Fast Pulldown Current (MAX5943A)	IG2DF	(VIN - VSENSE) > VTHF, VGATE2 = VOUT + 4.5V		80	125	200	mA
GATE2 Peak Pulldown Current (MAX5943A)	I _{G2DP}	(V _{IN} - V _{SENSE}) = 1V			1.0		A

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 7.5V \text{ to } 37V, \text{GND} = 0V, \text{ and } T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{IN} = 12V, T_A = +25^{\circ}\text{C}.)$ (Note 1)

PARAMETER	SYMBOL	COND	ITIONS	MIN	ТҮР	MAX	UNITS
GATE2 Pulldown Current During Any GATE2 Turn-Off Condition	IG20FF	$V_{GATE2} = V_{OUT} + 4.5V$ (Note 4)		80	125	200	mA
GATE1 (ORing control)							
ODing Switch Turn On Ourront			OR_ADJ = GND	3	5	7	mV
ORing Switch Turn-On Current Threshold Voltage	Vor	(VIN - V _{SENSE}) rising	OR_ADJ = floating	5.5	7.5	9.5	
			$OR_ADJ = IN$	8.5	10.5	12.8	
ORing Switch Turn-On Current Threshold Voltage Hysteresis		(V _{IN} - V _{SENSE}) falling			0.5		mV
GATE1 Pullup Current	lG1U	(Note 5)		36	45	54	μA
GATE1 High Voltage	V _{G1}	Vgate1 - Vsense	$7.5V \le V_{IN} \le 8V$	4.25	5.5	6.5	v
	vGT	VGATET - VSENSE	$8V \leq V_{IN} \leq 37V$	4.5	5.5	6.5	v
GATE1 Turn-Off Switch On- Resistance	R _{G1}	Measured between G/ when (V _{IN} - V _{SENSE}) <			2	3	Ω
LOGIC INPUTS							
ILIM, OR_ADJ Input-Logic Tristate Current Tolerance (Note 6)	IIX	Current into or out of input for tri-state logic condition		-3		+3	
	IIXL	Current out of input for	r logic low			20	μA
	IIН	Current into input for logic high				20	
LATCH, ONQ1 Input-Logic Low	VIL	Von > Von_ref				0.7	V
Voltage	١L	LATCH, ONQ1 = GND, $V_{ON} > V_{ON_{REF}}$				1	μA
LATCH, ONQ1 Input-Logic High Voltage	VIH	V _{ON} > V _{ON_REF}		1.8			V
LATCH, ONQ1 Input Current	Чн	All voltages = VIN, VOI	N > VON_REF			1	μA
TIM, ILIM, LATCH, OR_ADJ, OUT, ONQ1 Shutdown Mode Input Current	I _{IH_SD}	All voltages = V_{IN} , $V_{ON} \le 0.4V$				1	μΑ
FAULT Output Low Voltage	V _{OL}	Low-impedance state, $I_{FAULT} = 5mA$			0.12	0.25	V
FAULT Output High Leakage Current	IOH	High-impedance state, $V_{FAULT} = 37V$				1	μA
TIMING		1					
			TIM = IN	1.78	2.02	2.26	ms
Current-Limit Timeout	Current-	Current-limit mode	t-limit mode $R_{TIM} = 4k\Omega$		1.04	1.21	ms
(MAX5943A)	ЧLIМ	t _{ILIM} (Note 7)	$R_{TIM} = 50 k\Omega$	9.2	11.05	12.9	ms
			TIM = floating	120	175	225	ms

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 7.5V \text{ to } 37V, \text{ GND} = 0V, \text{ and } T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V_{IN} = 12V, T_A = +25^{\circ}\text{C}.)$ (Note 1)

PARAMETER	SYMBOL	CONDIT	TIONS	MIN	ТҮР	MAX	UNITS
			TIM = IN or $TIM \ge 3.4V$	0.45	0.51	0.57	ms
		Circuit-breaker mode,	$R_{TIM} = 4k\Omega$	27	32.5	38	μs
		MAX5943B	$R_{TIM} = 50 k\Omega$	228	345	403	μs
			TIM = floating	3.75	5.5	7	ms
			TIM = IN or $TIM \ge 3.4V$	0.89	1.00	1.13	ms
		Circuit-breaker mode,	$R_{TIM} = 4k\Omega$	54	65	76	μs
		MAX5943C	$R_{TIM} = 50k\Omega$	575	690	806	μs
Circuit-Breaker Timeout	t _{CB}		TIM = floating	7.5	10.9	14	ms
(MAX5943B-MAX5943E) (Note 7)	00		TIM = IN	1.78	2.02	2.26	ms
		Circuit-breaker mode,	$R_{TIM} = 4k\Omega$	109	130	151	μs
		MAX5943D	$R_{TIM} = 50k\Omega$	1.15	1.38	1.61	ms
			TIM = floating	15	21.9	28	ms
		Circuit-breaker mode, MAX5943E	TIM = IN or $TIM \ge 3.4V$	3.56	4.05	4.52	ms
			$R_{TIM} = 4k\Omega$	217	260	303	μs
			$R_{TIM} = 50k\Omega$	2.3	2.76	3.23	ms
			TIM = floating	30	44	56	ms
Automatic Restart Delay After Current-Limit/Circuit-Breaker Timeout	toff	LATCH = GND (Note 8)			128 x (t _{ILIM} OR ^t CB)		ms
GATE1 Turn-Off Time (ORing Response Time)	tor	From V _{OR} trigger until (V _{GATE1} - V _{IN}) < 1V, C _{GATE1} = 10nF			100		ns
Turn-Off Response Time	ton_off	Time from $V_{ON} < (V_{ON_OFF} - Hysteresis)$ until (V _{GATE2} - V _{OUT}) < 1V, GATE2 = open (Note 9)			0.34	0.6	μs
Minimum Delay from ON Low to Low-Current Shutdown Mode	tsd	ON step from 1.3V to 0.4V			50		μs

Note 1: All min/max parameters are tested at +25°C and +85°C. Limits at -40°C are guaranteed by design.

Note 2: Measured at both VGATE2 = VOUT = 0V and VGATE2 = VOUT = VIN.

Note 3: The typical value of parameter V_{THF} is 1.5 x V_{TH} .

Note 4: Current-Limit/Circuit-Breaker Timeout; IN or ON low.

Note 5: See the *Typical Operating Circuit*. Measured at V_{GATE1} = V_{SENSE}.

Note 6: The tristate ("floating") logic condition will be entered if the pin current is within these limits.

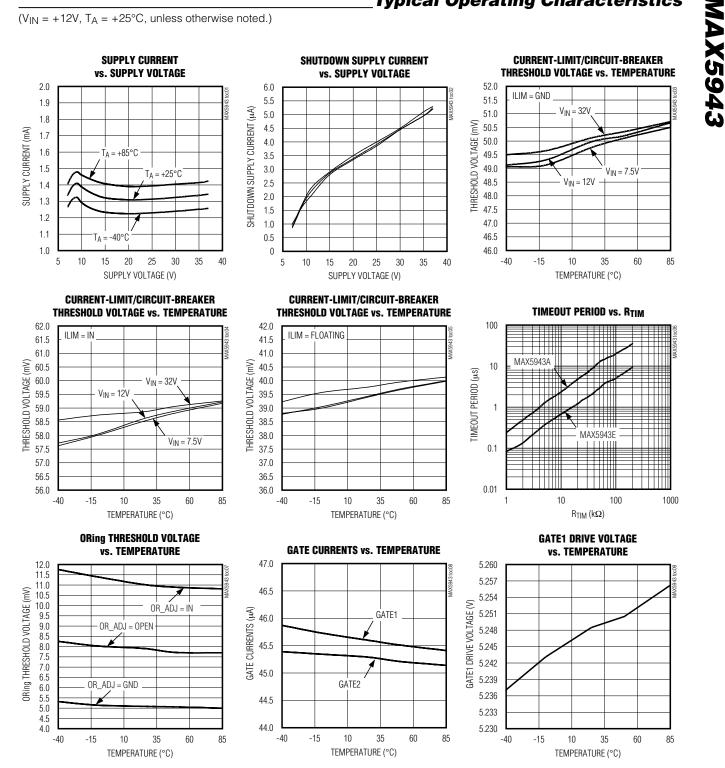
Note 7: RTIM is connected from TIM to GND. The maximum timeout period is enforced to prevent arbitrarily long operation in current-limit mode. Therefore, the relationship between resistor value and timeout changes for large values of RTIM. See Current-Limit Timeout vs. RTIM in the Typical Operating Characteristics for nominal values.

Note 8: Parameter tOFF is a direct multiple of tILIM (or tCB), so the limits for tOFF track the limits for tILIM (or tCB).

Note 9: If the ON voltage goes below VON_REF - Hysteresis, then GATE2 goes low immediately to disconnect power from the load quickly (within ton OFF).

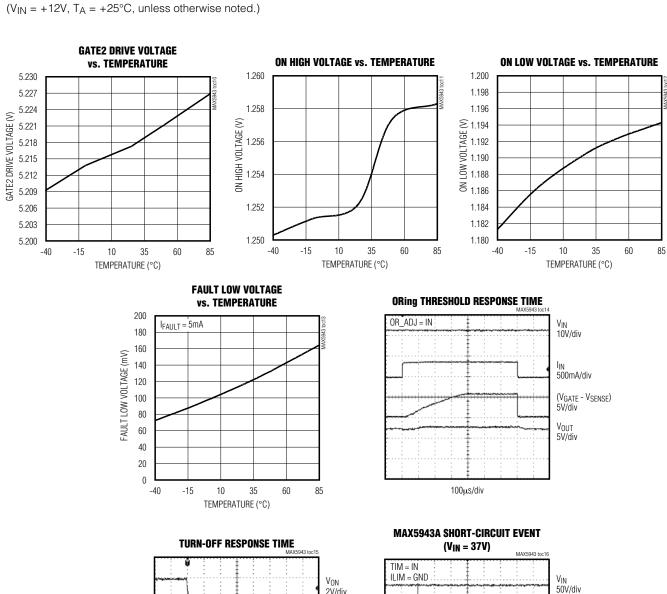
Typical Operating Characteristics

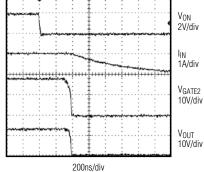
 $(V_{IN} = +12V, T_A = +25^{\circ}C, unless otherwise noted.)$



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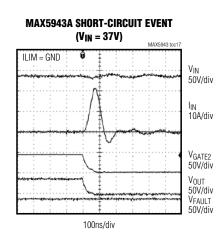
Typical Operating Characteristics (continued)

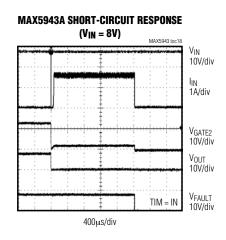
l_{IN} 1A/div V_{GATE2} 50V/div VOUT 50V/div V_{FAULT} 50V/div 400µs/div

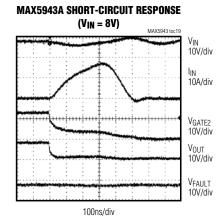


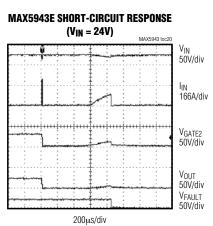
Typical Operating Characteristics (continued)

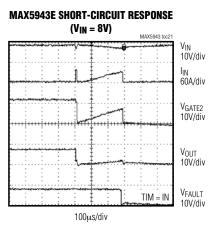
 $(V_{IN} = +12V, T_A = +25^{\circ}C, unless otherwise noted.)$

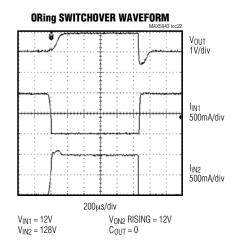






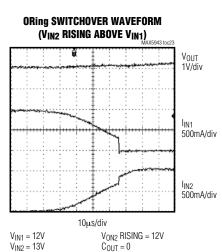


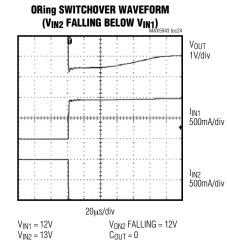




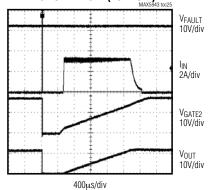
Typical Operating Characteristics (continued)

 $(V_{IN} = +12V, T_A = +25^{\circ}C, unless otherwise noted.)$



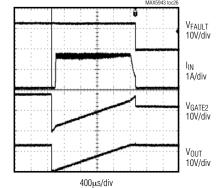


MAX5943A HOT PLUG-IN LOAD CAPACITANCE INTO ACTIVE PORT (NO FAULT)



 $\begin{array}{l} C_{LOAD}=220\mu\text{F}\\ \text{TIM}=\text{IN} \end{array}$

MAX5943A HOT PLUG-IN LOAD CAPACITANCE INTO ACTIVE PORT (CURRENT-LIMIT TIMEOUT)



 $\begin{array}{l} C_{LOAD}=470 \mu \text{F} \\ \text{TIM}=\text{IN} \end{array}$

Pin Description

PIN	NAME	FUNCTION
1	ON	On/Off-Control Input. ON sets the undervoltage lockout threshold and resets the part after a fault latch. Drive ON high to enable the device. Drive ON low to disable the device. Connect ON to IN for the default undervoltage lockout threshold. Connect a resistor-divider from IN to ON and GND to program the desired undervoltage lockout threshold.
2	FAULT	Current-Fault, Active-Low, Open-Drain Output. FAULT asserts and latches low after a current-limit/circuit- breaker fault has exceeded the current-limit/circuit-breaker timeout period (see the FAULT section).
3	TIM	Current-Limit/Circuit-Breaker Timeout Adjustment Input. Connect TIM to IN for the default timeout period or connect a resistor from TIM to GND to program the current-limit/circuit-breaker timeout period.
4	ILIM	Current-Limit/Circuit-Breaker Threshold Input. Leave ILIM open for a 40mV circuit-breaker threshold, connect to GND for a 50mV circuit-breaker threshold, or connect to IN for a 60mV circuit-breaker threshold (see the <i>Current Limiting</i> section).
5	LATCH	Latch or Autoretry Fault Management Selection Input. Connect LATCH to IN to select latch-off mode after a current-limit/circuit-breaker timeout. Connect LATCH to GND for autorestart mode after a current-limit/circuit-breaker timeout.
6	OR_ADJ	ORing Switch Turn-On Current Threshold Adjustment Input. Select one of three ORing switch turn-on threshold settings: connect OR_ADJ to GND, connect OR_ADJ to IN, or leave OR_ADJ floating (see the <i>Power-Supply ORing</i> section).
7, 10, 13	N.C.	No Connection. Not internally connected.
8	ONQ1	ORing Switch Manual Turn-On Input. Drive ONQ1 low to enable power-supply ORing. Drive ONQ1 high to set GATE1 high to allow reverse current flow. ONQ1 is disabled when V_{IN} is below the UVLO threshold, V_{ON} is below the V_{ON_REF} threshold, and after a current/circuit-breaker fault.
9	GND	Ground
11	OUT	Output Voltage Sense. Connect to the output.
12	GATE2	Current-Limiter Switch Gate Drive Output. Connect GATE2 to the gate of the 2nd n-channel MOSFET. GATE2 is a charge pump with a 45µA pullup current to 5.5V (typ) above OUT when active (see the <i>Typical Operating Circuit</i>).
14	GATE1	ORing Switch Gate-Drive Output. Connect GATE1 to the gate of the 1st n-channel MOSFET. GATE1 is a charge pump with a 45µA pullup current to 5.5V (typ) above SENSE when active (see the <i>Typical Operating Circuit</i>).
15	SENSE	Current-Sense Negative Input. Connect a current-sense resistor, R _{SENSE} , from IN to SENSE (see the <i>Typical Operating Circuit</i>).
16	IN	Input Power and Current-Sense Positive Input. Connect IN to the positive terminal of the current-sense resistor and to the power source (see the <i>Typical Operating Circuit</i>).

MAX5943

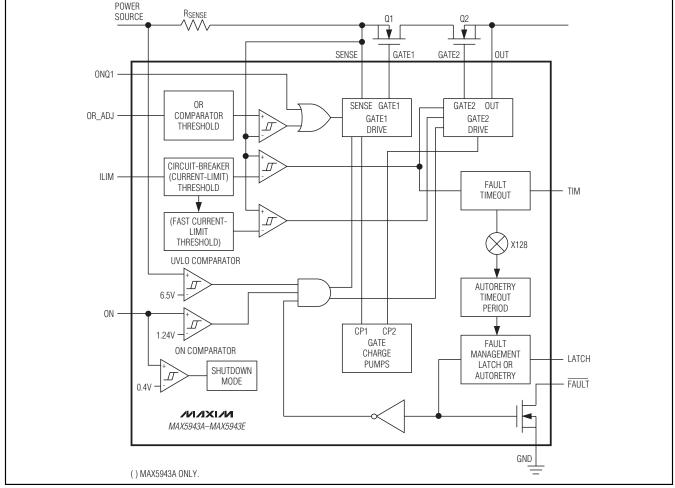


Figure 1. MAX5943 Functional Diagram

Detailed Description

The MAX5943 performs hot-swapping, power-supply ORing, and current limiting for FireWire power-supply applications. The MAX5943 incorporates two MOSFET drivers (GATE1 and GATE2) to control two external n-channel power MOSFETs to perform low-voltage-drop power-supply ORing (GATE1) and hot swapping and current limiting (GATE2) from the input power supply to the load. A sense resistor provides accurate currentlimiting/circuit-breaker function. GATE1 and GATE2 provide true load disconnect to prevent current flowing from either direction between IN and OUT.

The MAX5943 remains in low-current shutdown mode when V_{ON} is below the 0.4V threshold. Low-current shutdown mode disables the MAX5943, resulting in less than 10µA supply current. Shutdown places all

logic inputs in a high-impedance state allowing the inputs to be connected to IN without drawing additional current from the supply.

When the input supply voltage (V_{IN}) is above 7.5V and V_{ON} is above the V_{ON_REF} threshold, the MAX5943 turns on, sourcing 45µA current from GATE2 (current regulation) to enhance Q2 slowly. For the MAX5943A, if the voltage across the current-sense resistor, V_{IS}, is greater than the programmed current-limit threshold, the MAX5943A regulates the GATE2 voltage to limit the load current at the current-limit level so that V_{IS} is equal to V_{TH}. In normal operation, V_{IS} drops below V_{TH} and GATE2 rises to approximately 5.5V above OUT. Since the MAX5943B–MAX5943E do not regulate the load current, a capacitor can be added from GATE2 to GND to limit inrush current during startup (see the *Applications Information* section).



The MAX5943 current-limit/circuit-breaker timeout is programmable by connecting an external resistor from TIM to GND. The MAX5943A has a default 2ms currentlimit timeout. The MAX5943B, MAX5943C, MAX5943D, and MAX5943E have 0.5ms, 1ms, 2ms, and 4ms default circuit-breaker timeouts, respectively.

GATE1 controls the MAX5943 ORing function. Initially, GATE1 is off (ONQ1 = low) and the load current conducts through the body diode of Q1. GATE1 rises to 5.5V above SENSE when VIS exceeds VOR, thereby enhancing Q1 and reducing the voltage drop, power dissipation, and heat generation in the power-supply path. When a voltage greater than VIN is connected at OUT, the higher voltage source commences, providing current to the load. The MAX5943 rapidly turns off GATE1 upon VIS falling below VOR - hysteresis, thus blocking the higher voltage from back-driving VIN. GATE1 also turns off when the load current drops, causing VIS to fall below the VOR hysteresis.

Current Limiting/Circuit Breaker

Current Limiting (MAX5943A Only)

The MAX5943A limits the load current by monitoring the voltage across R_{SENSE} at all times and by regulating the current to the load as necessary to keep V_{IS} to its programmable current-limit threshold voltage (V_{TH}). Set the maximum current limit (I_{LIMIT}) by placing the appropriate sense resistor between IN and SENSE, where I_{LIMIT} = V_{TH}/R_{SENSE}. When the load current is less than I_{LIMIT}, GATE2 rises to V_{G2} (5.5V) to fully enhance MOSFET Q2 (see the *Typical Operating Circuit*).

When the load current attempts to draw more than ILIMIT, the MAX5943A's GATE2 pulldown current (IG2D) regulates the current through Q2 causing OUT to act as a constant-current source. The output current is limited to the programmed II IMIT. If the current-limit condition persists after the current-limit timeout (til IM) period has expired, GATE2's strong pulldown current (IG2 OFF) guickly turns off GATE2 to disconnect the load from the power supply. FAULT then asserts low (Figure 2a). If the current-limit duration is less than tILIM, GATE2 pulls to VG2 (Figure 2b). During an output short circuit or a gross overload, the load current overshoots and causes VIS to exceed the fast pulldown current-limit threshold voltage (VTHF). The MAX5943A responds with much stronger GATE2 pulldown currents (IG2DP and/or IG2DF) to quickly bring the load current back down to the programmed current limit.

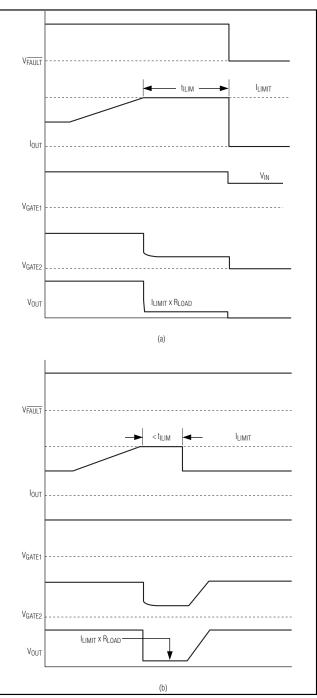


Figure 2. MAX5943A Current-Limit Timing Diagram

MAX5943B–MAX5943E Circuit Breaker

The MAX5943B–MAX5943E provide a circuit-breaker function that protects against excessive load currents and short-circuit conditions. The load current is monitored by sensing the voltage across an external sense resistor (RSENSE) and disconnects the load from the power source when the voltage across RSENSE, VIS, exceeds the programmed circuit-breaker thresholds (VTH) for longer than the circuit-breaker timeout period, t_{CB}.

Unlike the MAX5943A, when an output short circuit or overcurrent occurs, the MAX5943B–MAX5943E keep GATE2 fully enhanced. The short-circuit current is limited only by the input source impedance, R_{SENSE}, Q1's R_{DS(ON)}, Q2's R_{DS(ON)}, and any parasitic impedance in the power path. If the excessive current condition persists (as indicated by V_{IS} > V_{TH}) for longer than t_{CB}, GATE2 turns off with a strong pulldown (I_{G2} OFF) to quickly disconnect the power source from the load and FAULT asserts low (Figure 3).

Exercise caution when using the MAX5943B–MAX5943E. Unlike the MAX5943A, the MAX5943B–MAX5943E do not limit the load current during t_{CB}. High current during t_{CB} may cause damage to external devices connected in the power path.

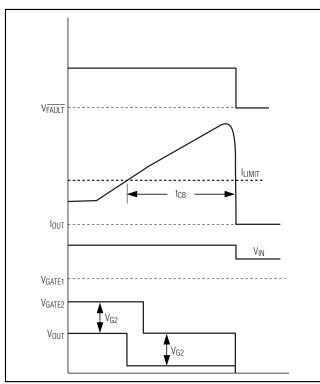


Figure 3. MAX5943B-MAX5943E Circuit-Breaker Timing Diagram

Current-Limit/Circuit-Breaker Thresholds

The MAX5943 allows three selectable current-limit/circuit-breaker thresholds (VTH). Choose the voltage threshold by connecting ILIM to the appropriate level; see Table 1.

Table 1. Current-Limit/Circuit-BreakerTrip Threshold Level

ILIM CONNECTION	V _{TH} (mV)
Open	40
GND	50
IN	60

Current-Limit/Circuit-Breaker Timeout Period (t_{ILIM}/tcB)

The MAX5943's current-limit/circuit-breaker timeout function disconnects power from the load if the currentlimit or circuit-breaker threshold voltage exceeds its maximum limit for a programmable amount of time. Connect TIM to IN for the MAX5943 default timeout periods (see Table 2).

Adjust the fault timeout period (t_{ILIM}/ t_{CB}) by connecting a resistor (R_{TIM}) from TIM to GND (see the *Typical Operating Characteristics*). Calculate the fault-limit timeout period using the following equation:

$$t_{ILIM}$$
 (ms) = t_{CB} (ms) = 0.25 x $\frac{R_{TIM}}{K}$ (k Ω)

where RTIM is in k Ω , t_{ILIM}/t_{CB} is in ms, and K = 1 for MAX5943A, K = 32 for MAX5943B, K = 16 for MAX5943C, K = 8 for MAX5943D, and K = 4 for the MAX5943E.

Table 2. MAX5943_	Timeout Periods
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PART	DEFAULT TIMEOUT, TIM = IN (ms)	PROGRAMMABLE TIMEOUT RANGE (4kΩ < R _{TIM} < 50kΩ)	MAXIMUM TIMEOUT, TIM = FLOATING (ms)
MAX5943A	2	1.04ms to 11.05ms	175
MAX5943B	0.5	32.5µs to 345µs	4.8
MAX5943C	1	65µs to 690µs	9.6
MAX5943D	2	130µs to 1.38ms	19.2
MAX5943E	4	260µs to 2.76ms	38.4



Timing accuracy is guaranteed for R_{TIM} ranging from $4k\Omega$ to $50k\Omega$. Large R_{TIM} values can be used, which reduces timing accuracy. A maximum timeout period is enforced to prevent arbitrarily long operation in current-limit/circuit-breaker conditions.

Long durations in current-limit/circuit-breaker mode may produce excessive heating and electrical stresses in R_{SENSE}, Q1, Q2, and any other components in the power path. Use component values rated to handle electrical stresses during the timeout period.

Power-Supply ORing (ONQ1 = Low)

GATE1 controls the MAX5943 ORing function. The MAX5943 accomplishes a very-low-voltage-drop diode ORing function using an n-channel power MOSFET, Q1. Initially, GATE1 is off (ONQ1 = low) and the load current conducts through the body diode of Q1 (Figure 4). GATE1 rises to 5.5V above SENSE when VIS exceeds V_{OR}, enhancing Q1. Q1's low R_{DS(ON}) provides a very-low-voltage drop across its source to drain, reducing voltage drop, power dissipation, and heat generation in the power-supply path created by a traditional diode.

The MAX5943 continuously monitors the load current by the voltage drop, V_{IS} , across the current-sensing resistor. Q1 turns off rapidly when V_{IS} decreases below V_{OR} minus its hysteresis.

Set the MAX5943 ORing threshold (VOR) by connecting OR_ADJ to GND for a 5mV threshold, or to IN for a 10mV threshold, or leave it open for a 7.5mV threshold. Connect ONQ1 to GND for normal ORing function. Drive ONQ1 high to force Q1 on, regardless of the load current condition, as long as the voltages at IN and ON exceed VUVLO and VON_REF, respectively, and the device is not in a current fault shutdown.

When a higher voltage supply is connected at OUT (Figure 5), the sense voltage drops below the programmable ORing threshold. The MAX5943 immediately turns off Q1, blocking reverse current flow from OUT to IN. The power is then routed from the higher supply input to the load (Figure 6).

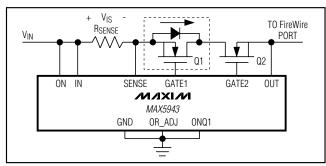
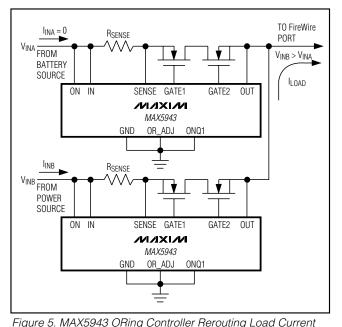


Figure 4. Q1 Current Path During Inital Startup



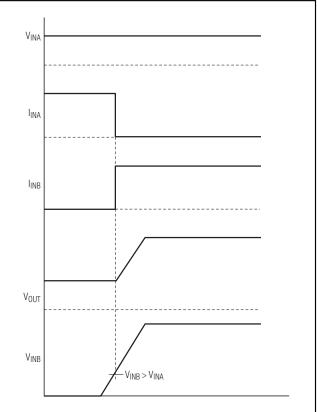


Figure 6. MAX5943 Power Switch Over ORing Timing Diagram

Reverse Current Override (ONQ1 = High)

Drive ONQ1 high to disable the power-supply ORing function. Disabling the MAX5943 ORing function allows reverse current flow through the power-supply system. When ONQ1 is high, GATE1 remains fully enhanced as long as V_{IN} is greater than V_{UVLO}, V_{ON} is above the V_{ON_REF} threshold, and the MAX5943 is not in a current-limit or circuit-breaker fault condition. The MAX5943 reverse-current flow feature permits a higher voltage source connected to one port to route power to another port, as long as the voltage at IN remains above the minimum 7.5V operating range (see Figure 7).

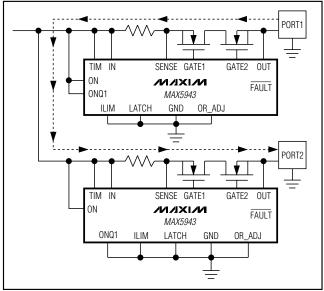


Figure 7. MAX5943 Operating in Reverse-Current Mode (Routing Power from Port 1 to Port 2)

Undervoltage Lockout

The MAX5943 operates from 7.5V to 37V and has a default 6.5V undervoltage lockout threshold. The external MOSFETs remain off as long as $V_{IN} > 6.5V$ and $V_{ON} < V_{ON_REF}$. The turn-on threshold is programmable by connecting a resistor-divider at ON. When $V_{ON} > 1.24V$ and $V_{IN} > 7.5V$, GATE2 is enhanced to 5.5V, with respect to OUT and the MAX5943 goes into normal operation.

Program the MAX5943's turn-on voltage using the following formula:

$$R1 = \left(\frac{V_{TURN}ON}{1.24} - 1\right) \times R2$$

where V_{TURN_ON} is the desired turn-on voltage of the MAX5943. Choose an R2 value in the 1k Ω range to minimize error due to the ON bias current.

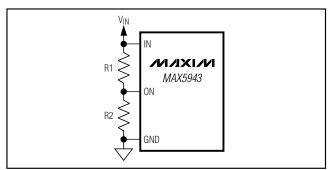


Figure 8. Setting the MAX5943 Turn-On Voltage

When operating the MAX5943, ON must remain above its 1.24V threshold. If V_{ON} falls below its 1.24V threshold, the power-supply MOSFETs (Q1 and Q2) turn off immediately (less than 1µs). This allows the power supply to disconnect in the event of a fault condition detected by the system, such as shorting of the output to a different power-supply voltage or a FireWire signal pin. If possible transient conditions exist at the main power-supply line (IN), place an RC filter at ON to reject transient voltage dips and to prevent unnecessary power-supply interruptions.

The MAX5943 remains in low-current shutdown mode when V_{ON} is below the 0.4V threshold. Low-current shutdown mode disables the MAX5943 resulting in less than 10µA supply current. Shutdown places all logic inputs in a high-impedance state allowing the inputs to be connected to IN without drawing additional current from the supply. An internal delay, t_{SD}, allows Q1 and Q2 to be turned off before the MAX5943 enters low-current shutdown mode.

Fault Status Output (FAULT)

FAULT is a high-voltage open-drain output that pulls low when a current-limit/circuit-breaker fault shutdown has occurred. FAULT remains low until the next startup cycle.

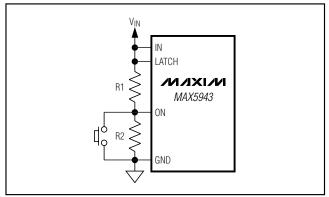


Figure 9. Resetting MAX5943 After a Latched Fault Condition



Fault Management

The MAX5943 offers either latch or autoretry fault management configurable by the LATCH input. Connect LATCH to IN for latch fault management or connect LATCH to GND for <u>autoretry</u> fault management. In latch fault management, FAULT latches low, GATE1 and GATE2 latch off indefinitely. Cycle ON low and then high to unlatch and restart the MAX5943. However, the MAX5943 will not enter a startup cycle until tOFF has expired. Figure 9 illustrates a way to reset the MAX5943 after a fault using a pushbutton switch.

In autoretry fault management, the MAX5943_ attempt to restart after a toFF of 128 x tiLIM (or 128 x tcB) limiting the duty cycle of the MOSFETs to 1/129 under continuous fault conditions. FAULT deasserts every time a restart attempt is made.

Applications Information Startup Consideration MAX5943A

During startup, a large capacitor at OUT may result in a charging current equivalent to the current limit. Choose a current-limit timeout that will allow a successful startup. The timeout can be approximated using the following equation:

where ILIMIT is the programmed current limit, COUT is the capacitor at OUT, VIN is the supply voltage, and ILOAD is the load current during startup. With IN = 12V, COUT = 330μ F, ILIMIT = 1.5A, and ILOAD = 0, the MAX5943 commences by charging the output capacitor with 1.5A for approximately 2.7ms. Therefore, the MAX5943A current-limit timeout period (tILIM) should be greater than 2.7ms for a successful startup. Otherwise, the MAX5943A powers up in fault management mode by exceeding the current-limit timeout period.

MAX5943B-MAX5943E

The MAX5943B–MAX5943E do not control the inrush current during startup. Inrush current control can be implemented by placing a resistor and capacitor at GATE2 (Figure 10) to slowly ramp up the gate voltage, thus limiting the inrush current. The inrush current can be approximated using the following formula:

$$I_{\text{INRUSH}} = \frac{C_{\text{OUT}}}{C_{\text{GATE2}}} \times I_{\text{G2U}} + I_{\text{LOAD}}$$

Where I_{G2U} is GATE2's 45µA sourcing current and I_{LOAD} is the load current at startup.

To prevent the MAX5943B–MAX5943E from starting up in a fault condition set:

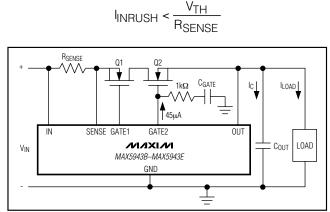


Figure 10. Controlling the MAX5943B-MAX5943E Inrush Current

Optimizing for Short-Circuit Conditions Choosing Rsense

Select a sense resistor that causes the circuit-breaker voltage drop at a current-limit/circuit-breaker level above the maximum normal operating current. Typically, set the overload current at 1.2 to 1.5 times the full load current.

Choose the sense-resistor power rating to accommodate an overcurrent condition:

$PRSENSE = I^2 LIMIT \times RSENSE$

where PRSENSE is the power dissipated across RSENSE during a current-limit/circuit-breaker fault.

Under short-circuit conditions, it is imperative that the appropriate sense resistor is utilized. Operating the MAX5943B–MAX5943E at high input voltages can cause very large currents during the circuit-breaker timeout period. The peak current will be limited by the saturation current of Q2 or the series resistance in the power path (RTOTAL).

Using a $30m\Omega$ on-resistance MOSFET at GATE1 and GATE2 and a $30m\Omega$ sense resistor results in a short-circuit current approximately equal to:

$$I_{SC} = V_{IN}/R_{TOTAL}$$

where:

$$R_{TOTAL} = R_{SENSE} + 2 \times (R_{ON})$$

 $= 30m\Omega + 2 \times (30m\Omega) = 90m\Omega$

For example, an input voltage of 20V produces a current at approximately 222A (or I_{SAT} of Q2, whichever is less) in the power path for the circuit-breaker timeout period. Choose an R_{SENSE} capable of handling the high power dissipation during a short-circuit event.

MOSFET Selection

Select external MOSFETs according to the application current level. The MOSFETs' on-resistance ($R_{DS(ON)}$) should be chosen low enough to have minimum voltage drop at full load to limit the MOSFET power dissipation. High $R_{DS(ON)}$ also causes large output ripple if there is a pulsating load. Determine the device power rating to accommodate startup, a short-circuit condition, and when the device is in autoretry mode.

During normal operation, the external MOSFETs dissipate little power. The power dissipated in normal operation is:

$P = I_{LOAD^2} \times RDS(ON)$

The most power dissipation occurs during a short-circuit event, resulting in high power dissipated in Q2 (Figure 11) during the timeout period for the MAX5943A, where the power dissipated across Q2 is:

$$P_{Q2} = (V_{IN} - V_{IS} - V_{Q1}) \times I_{LIMIT}$$

For the MAX5943B–MAX5943E, a short-circuit event results in high power dissipated in both Q1 and Q2 during the timeout period (Figure 13) where the total power dissipated in either MOSFET is:

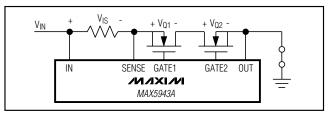
 $P = I_{SC^2} \times R_{DS(ON)}$

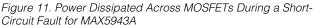
where:

$$I_{SC} = V_{IN}/R_{EQ}$$

and

$$R_{EQ} = R_{SENSE} + R_{DS(ON1)} + R_{DS(ON2)}$$





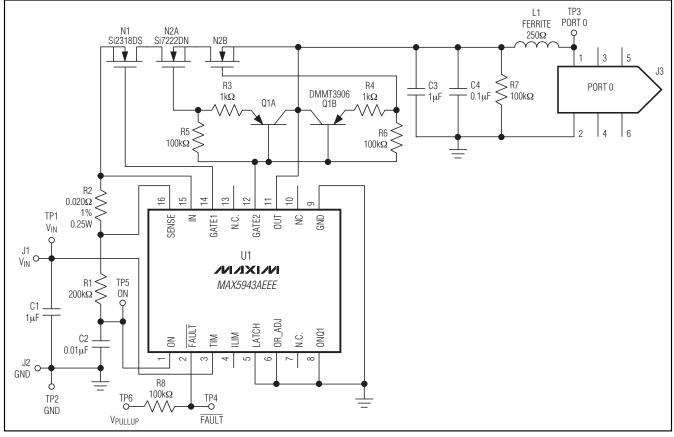


Figure 12. UL-Recognized Single-Port FireWire Protective Circuit

The programmable timeout of the MAX5943 allows the use of MOSFETs with low power ratings. A MOSFET typically withstands single-shot pulses with higher dissipation than the specified package rating.

A single-port FireWire protective circuit employing the MAX5943A has been UL recognized as a result of extensive safety testing by Underwriters Laboratories. It is the circuits themselves, not any individual component

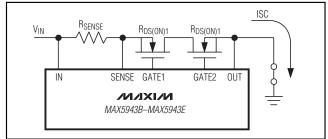
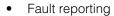


Figure 13. Power Dissipated Across MOSFETs During a Short-Circuit Fault for MAX5943B–MAX5943E

thereof, that are UL recognized. The circuit is further described in Application Note 3984—UL Recognized, *IEEE 1394 Single- and Dual-Port FireWire Protective Circuits* available at www.maxim-ic.com/appnotes.cfm/ appnote_number/3984.

The circuit provides:

- 2.5A (adjustable) current limiting to the load at initial connection or in overload fault condition
- 2ms (adjustable) current-limit timeout before load disconnect for excessive load current
- Automatic-restart attempts after a fault shutdown condition
- <0.8% current-limited duty cycle in continuous fault condition
- 6.5V undervoltage shutdown protection
- Low-drop ORing in multiple power-source applications, and



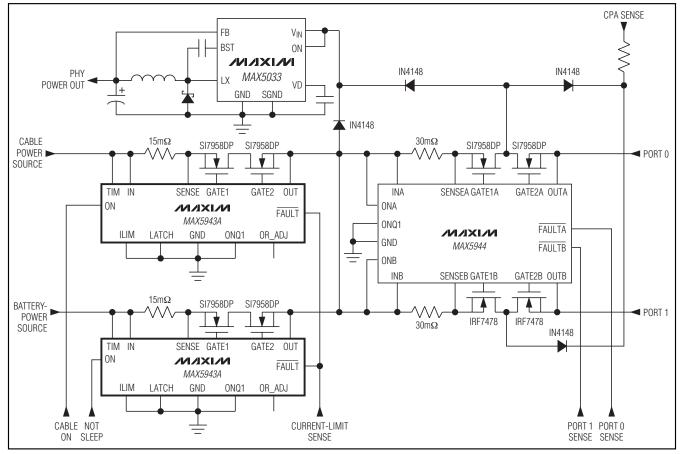


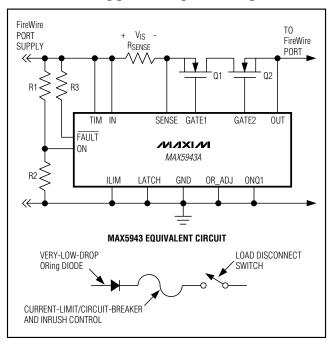
Figure 14. Two-Port FireWire Power Provider Using MAX5943A and MAX5944

FireWire Power Management

The MAX5943 serves to regulate and protect FireWire power over a system interface. The MAX5943 programmable features make it suitable for both power provider and power receiver applications. Figure 14 shows a high-end two-port FireWire power management system using two MAX5943As and a dual-channel MAX5944 FireWire current-limiting IC.

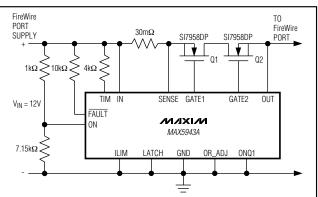
Transient Protection

If IN or OUT experiences a fast voltage transient, the drain-to-gate parasitic capacitance of Q1 and/or Q2 may be sufficient to briefly enhance one of the transistors, allowing current glitch. If the circuit is subjected to large transients, connect capacitors from the gate to source across the appropriate MOSFET, preventing the parasitic capacitance from turning on the device.



Typical Operating Circuit

Caution: The additional gate-to-source capacitance causes the turn-off time of the MOSFETs to increase due to the additional charge of the capacitor. Use the minimum capacitor value to prevent currents from flow-ing in hot-plug situations.



_Typical Application Circuit

Selector Guide

PART	CURRENT LIMITER/ CIRCUIT BREAKER	DEFAULT TIMEOUT (ms)	PROGRAMMABLE TIMEOUT RANGE
MAX5943A	Current limit	2	1.04ms to 11.05ms
MAX5943B	Circuit breaker	0.5	32.5µs to 345µs
MAX5943C	Circuit breaker	1	65µs to 690µs
MAX5943D	Circuit breaker	2	130µs to 1.38ms
MAX5943E	Circuit breaker	4	260µs to 2.76ms

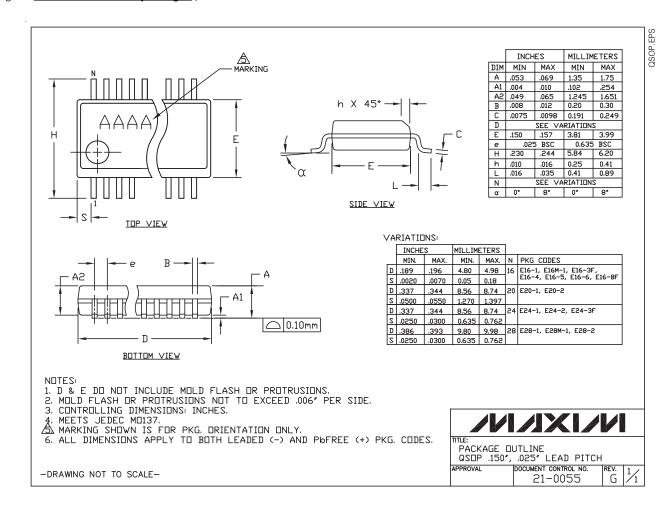
Chip Information

TRANSISTOR COUNT: 2324 PROCESS: BICMOS

WAX5943

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>www.maxim-ic.com/packages</u>.)



MAX5943

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/04	Initial release	
1	1/05	Corrected Table 2 and Figures 10, 11, and 12	12, 15, 16, 17
2	10/07	Added FireWire/IEEE and UL information, inserted new Figure 12, and updated Package Outline	1, 16, 17, 18, 20

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Revision History